

PNP SILICON POWER TRANSISTOR

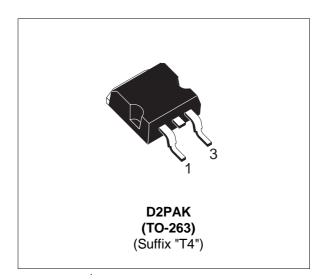
- SURFACE-MOUNTING D²PAK (TO-263) POWER PACKAGE IN TAPE & REEL (SUFFIX "T4")
- ELECTRICALLY SIMILAR TO TIP32B

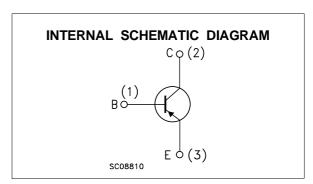
APPLICATION

 LINEAR AND SWITCHING INDUSTRIAL EQUIPMENT

DESCRIPTION

The MJB32B is manufactured using Epitaxial-base Technology for use in medium power linear and switching applications.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage (I _E = 0)	-80	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	-80	V
V_{EBO}	Emitter-Base Voltage (I _C = 0)	-5	V
Ic	Collector Current	-3	А
I _{CM}	Collector Peak Current	-5	А
Ι _Β	Base Current	-1	А
P _{tot}	Total Dissipation at T _{case} ≤ 25 °C	40	W
	T _{amb} ≤ 25 °C	2	W
T _{stg}	Storage Temperature	-65 to 150	O°
Tj	Max. Operating Junction Temperature	150	O°

June 2001 1/5

THERMAL DATA

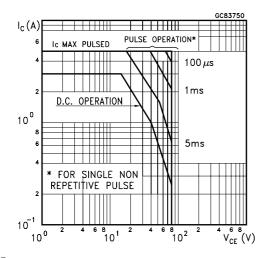
R _{thj-case}	Thermal Resistance Junction-case	Max	3.12	°C/W
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

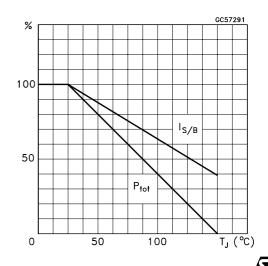
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CEO}	Collector Cut-off Current (I _B = 0)	V _{CE} = -60 V			-50	μΑ
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = -80 V			-20	μΑ
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = -5 V			-0.1	mA
V _{CEO(sus)*}	Collector-Emitter Sustaining Voltage (I _B = 0)	Ic = -30 mA	-80			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_C = -3 \text{ A}$ $I_B = -375 \text{ mA}$			-1.2	V
$V_{BE}*$	Base-Emitter Voltage	$I_C = -3 A$ $V_{CE} = -4 V$			-1.8	V
h _{FE} *	DC Current Gain	Ic = -1 A	25 10		50	
h _{fe}	Small Signall Current Gain	I _C = -0.5 A V _{CE} = -10 V f = 1 KHz I _C = -0.5 A V _{CE} = -10 V f = 1 MHz	20 3			

^{*} Pulsed : pulse duration = 300 μs, duty cycle ≤ 2%

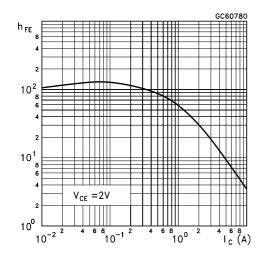
Safe Operating Area



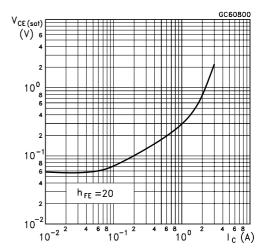
Derating Curves



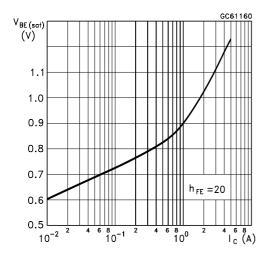
DC Current Gain



Collector-Emitter Saturation Voltage

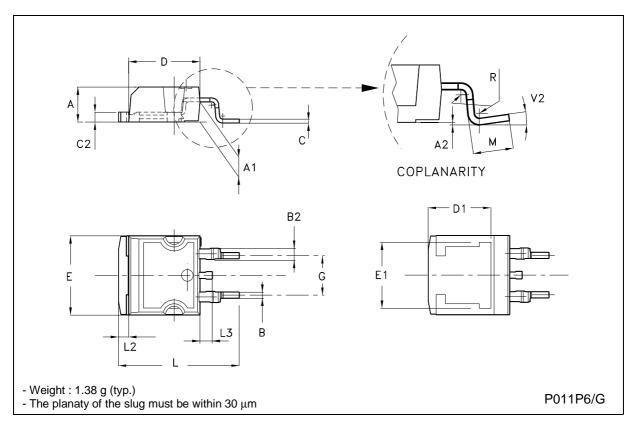


Collector-Base Capacitance



TO-263 (D²PAK) MECHANICAL DATA

DIM.	mm		inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
В	0.70		0.93	0.027		0.036
B2	1.14		1.70	0.044		0.067
С	0.45		0.60	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1		8.00			0.315	
E	10.00		10.40	0.393		0.409
E1		8.50			0.334	
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.4	0.050		0.055
L3	1.40		1.75	0.055		0.068
М	2.40		3.2	0.094		0.126
R		0.40			0.016	
V2	0°		8°	0°		8°



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